

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	BAV19WS	BAV20WS	BAV21WS	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage	V _{RWM} V _R	100	150	200	V
RMS Reverse Voltage	V _{R(RMS)}	71	106	141	V
Forward Continuous Current (Note 5)	I _{FM}	250			mA
Average Rectified Output Current (Note 5)	I _O	200			mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 100μs @ t = 10ms	I _{FSM}	9.0			A
		3.0			
		1.7			
Repetitive Peak Forward Surge Current	I _{FRM}	625			mA

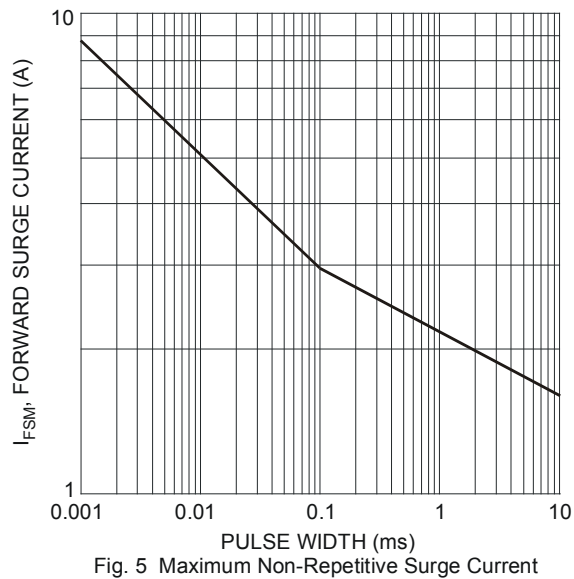
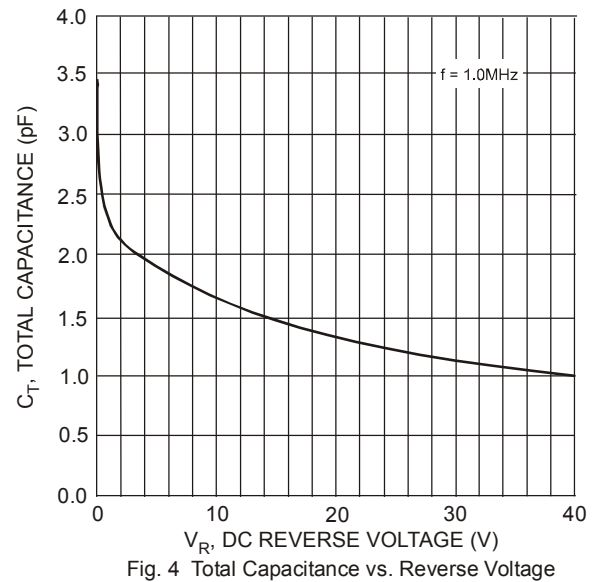
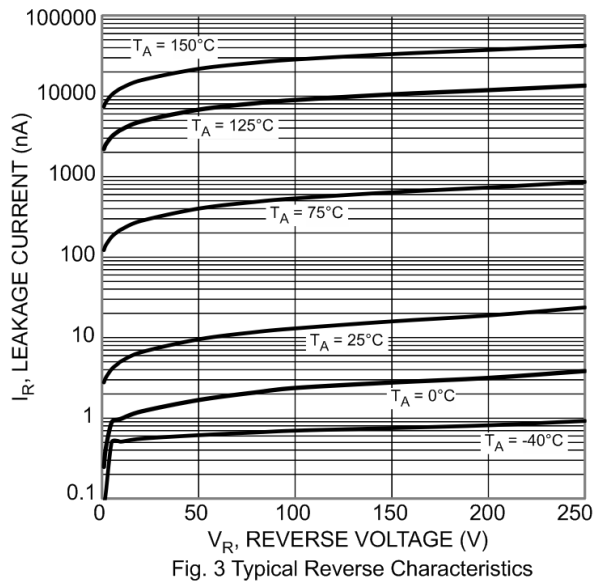
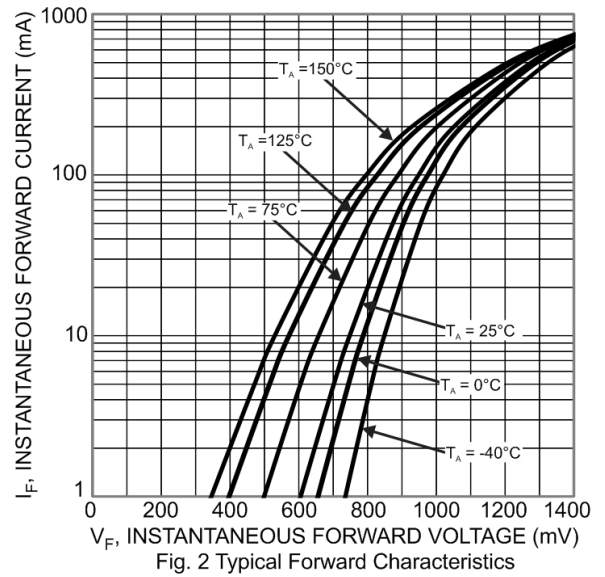
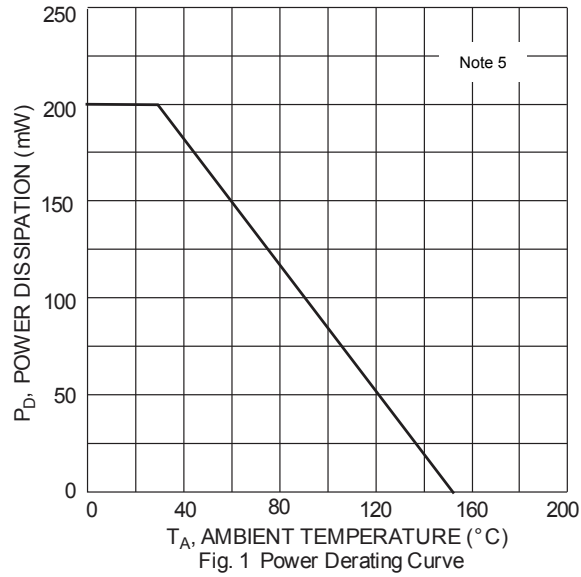
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation	P_D	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	625	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6) BAV19WS BAV20WS BAV21WS	$V_{(BR)R}$	120 200 250	—	V	$I_R = 100\mu\text{A}$
Forward Voltage	V_F	—	1.0 1.25	V	$I_F = 100\text{mA}$ $I_F = 200\text{mA}$
Peak Reverse Current @ Rated DC Blocking Voltage (Note 6)	I_R	—	100 15	nA μA	$T_J = +25^\circ\text{C}$ $T_J = +100^\circ\text{C}$
Total Capacitance	C_T	—	5.0	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{RR}	—	50	ns	$I_F = I_R = 30\text{mA}$, $I_{RR} = 0.1 \times I_R, R_L = 100\Omega$

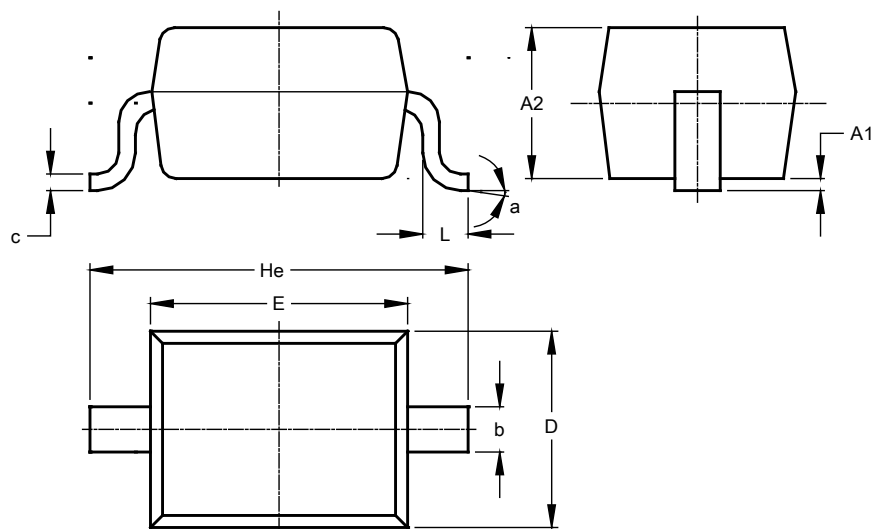
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
6. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD323

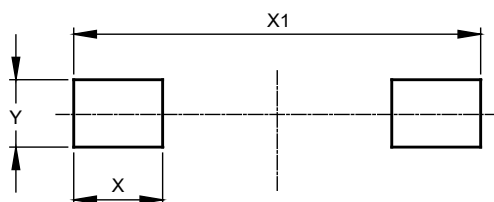


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Dim	Min	Max	Typ
A1	--	0.10	0.05
A2	1.00	1.10	1.05
b	0.25	0.35	0.30
c	0.10	0.15	0.11
D	1.20	1.40	1.30
E	1.60	1.80	1.70
He	2.30	2.70	2.50
L	0.20	0.40	0.30
a	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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Dimensions	Value (in mm)
X	0.590
X1	2.700
Y	0.450

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